

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6501046

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JOHN J. ELLIS-MONAGHAN	11/09/2020
ANUPAM DUTTA	11/05/2020
SATYASURESH V. CHOPPALLI	11/05/2020
VENKATA N.R. VANUKURU	11/10/2020
MICHEL ABOU-KHALIL	11/04/2020
RECEIVING PARTY DATA	
Name:	GLOBALFOUNDRIES U.S. INC.
Street Address:	2600 GREAT AMERICA WAY
City:	SANTA CLARA
State/Country:	CALIFORNIA
Postal Code:	95054
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17151343
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Email:	ptocommunications@hoffmanwarnick.com, dcole@hoffmanwarnick.com
Correspondent Name:	HOFFMAN WARNICK LLC
Address Line 1:	540 BROADWAY
Address Line 2:	4TH FLOOR
Address Line 4:	ALBANY, NEW YORK 12207
ATTORNEY DOCKET NUMBER:	GF2020180-US-NP
NAME OF SUBMITTER:	MATTHEW J. KINNIER
SIGNATURE:	/Matthew J. Kinnier/
DATE SIGNED:	01/18/2021
Total Attachments: 5	
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**COMBINED DECLARATION and ASSIGNMENT (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION
USING AN APPLICATION DATA SHEET (37 CFR 1.76)**

**Title of
Invention**

**INTEGRATED CIRCUIT (IC) STRUCTURE WITH AMORPHOUS
SEMICONDUCTOR MATERIAL BETWEEN SUBSTRATE AND TRANSISTOR**

DECLARATION

As the below named inventor, I hereby declare that:

This declaration
is directed to:



The attached application, or



United States application or PCT international application number _____ filed on

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

I have reviewed and understand the contents of the application and am aware of the duty to disclose to the US Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR § 1.56.

ASSIGNMENT

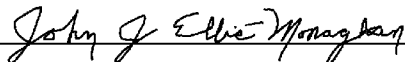
For good and valuable consideration, the receipt, sufficiency and adequacy of which are hereby acknowledged, I hereby sell, assign, transfer, to GLOBALFOUNDRIES U.S. Inc., having a business address of 2600 Great America Way, Santa Clara, CA 95054 U.S.A., its successors and assigns, absolutely and forever, my entire right, title and interest in and to the invention listed above, together with the Application, any and all Patents that may issue in the United States and/or any foreign countries, and any reissues, re-examinations, renewals, continuations, continuation-in-parts, divisionals or extensions thereof that may be issued or granted, and all right, title and interest to the inventions contained in said Patents and Applications, for the United States and all foreign countries, and all the rights and privileges relating thereto including but not limited to the priority rights arising from said Applications, the right to recover and take all such proceedings as may be necessary for the recovery of damages or otherwise in respect of past, present and future infringement, and the right to apply for, take and maintain patents on said inventions.

If any portion of this Combined Declaration or Assignment is held unenforceable, then remaining portions hereof shall nevertheless remain in full force and effect.

LEGAL NAME OF INVENTOR

Inventor: John J. Ellis-Monaghan

Date : 11/09/2020

Signature: 

Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use an additional form for each additional inventor.

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LEGAL NAME OF INVENTOR

Inventor: Anupam Dutta

Date : 5th November, 2020

Signature: 

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LEGAL NAME OF INVENTOR

Inventor: Satyasuresh V. Choppalli

Date : 11/05/2020

Signature: 

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LEGAL NAME OF INVENTOR

Inventor: Venkata N.R. Vanukuru

Date : Nov 10th 2020

Signature: _____

V. V. Narayana Rao

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LEGAL NAME OF INVENTOR

Inventor: Michel Abou-Khalil

Date : 11/04/2020

Signature: _____



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